

Electronic Patent Application Fee Transmittal

Application Number:	10730047			
Filing Date:	09-Dec-2003			
Title of Invention:	Semiconductor chip and method for manufacturing the same			
First Named Inventor:	Shunpei Yamazaki			
Filer:	John F. Hayden/April Saunders-Fuller			
Attorney Docket Number:	12732-185001			
Filed as Large Entity				
Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issurance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Submission- Information Disclosure Stmt	1806	1	180	180
Total in USD (\$)				180